

60V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BVDSS	Rds(on) Max	I _D Max T _A = +25°C
60V	5mΩ @ V _{GS} = 10V	17.0A
	6.9mΩ @ V _{GS} = 4.5V	14.5A

Description and Applications

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high efficiency power management applications.

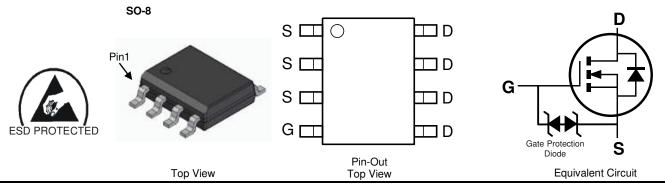
- High Frequency Switching
- Synchronous Rectification
- DC-DC Converters

Features and Benefits

- 100% Unclamped Inductive Switching (UIS) Test in Production— Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)}—Minimizes On-State Losses
- Low Input Capacitance
- Fast Switching Speed
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish—Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208
- Weight: 0.076 grams (Approximate)



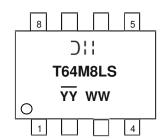
Ordering Information (Note 4)

Part Number	Case	Packaging	
DMT64M8LSS-13	SO-8	2,500/Tape & Reel	

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



☐ Hanufacturer's Marking
☐ Hanufacturer's Mar



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	60	V		
Gate-Source Voltage	V_{GSS}	±20	V		
Continuous Drain Current (Note 5) Ves 10V	$T_A = +25^{\circ}C$	_	13.6	A	
Continuous Drain Current (Note 5) VGS = 10V	T _A = +70°C	lο	10.9		
Continuous Drain Current (Note C) Ves 10V	T _A = +25°C	,	17.0	۸	
Continuous Drain Current (Note 6) Vgs = 10V	T _A = +70°C	lο	13.6	Α	
Maximum Continuous Body Diode Forward Current (Note 6)	Is	17.0	Α		
Pulsed Drain Current (10μs Pulse, Duty Cycle = 1%)	I _{DM}	130	Α		
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)		lsм	130	Α	
Avalanche Current, L = 0.3mH		las	27.2	Α	
Avalanche Energy, L = 0.3mH		Eas	111	mJ	

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.4	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Rөja	89.5	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	PD	2.2	W
Thermal Resistance, Junction to Ambient (Note 6) Steady State		Rөja	57.5	°C/W
Thermal Resistance, Junction to Case (Note 6)	Rejc	6.5	°C/W	
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (T_A = +25°C, unless otherwise specified.)

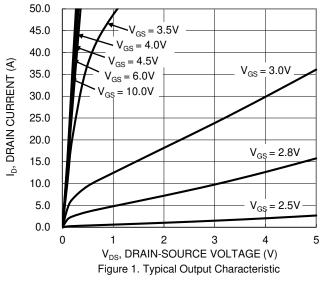
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BVDSS	60	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$
Zero Gate Voltage Drain Current	I _{DSS}		_	1	μA $V_{DS} = 48V, V_{GS} = 0V$	
Gate-Source Leakage	lgss	_	_	±10	μA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(TH)}	1.3	_	2.3	V	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$
Chatia Duain Causaa On Basistanaa		_	3.9	5	0	V _G S = 10V, I _D = 20A
Static Drain-Source On-Resistance	RDS(ON)		5.3	6.9	mΩ	V _{GS} = 4.5V, I _D = 12.5A
Diode Forward Voltage	VsD	_	0.8	1.2	V	V _G S = 0V, I _S = 20A
DYNAMIC CHARACTERISTICS (Note 8)			•			•
Input Capacitance	Ciss	_	2664	_		V _{DS} = 30V, V _{GS} = 0V, f = 1MHz
Output Capacitance	Coss	_	955	_	pF	
Reverse Transfer Capacitance	C _{rss}	_	75	_		
Gate Resistance	Rg		0.76		Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge (VGS = 4.5V)	Qg		26.1			
Total Gate Charge (VGS = 10V)	Qg	_	47.5	_	nC	V _{DD} = 30V. I _D = 20A
Gate-Source Charge	Qgs	_	6.2	_	IIC	VDD = 30V, ID = 20A
Gate-Drain Charge	Qgd		12.5	_		
Turn-On Delay Time	td(ON)	_	6.4	_		
Turn-On Rise Time	t _R	_	9.1	_	20	$\begin{split} V_{DD} &= 30 V, V_{GS} = 10 V, \\ I_D &= 20 A, R_g = 3.3 \Omega \end{split}$
Turn-Off Delay Time	tD(OFF)	_	29.8	_	ns	
Turn-Off Fall Time	tF	_	18.3	_		
Body Diode Reverse Recovery Time	t _{RR}	_	41	_	ns I con divide doon (co	
Body Diode Reverse Recovery Charge	Qrr	_	53	_	nC I _F = 20A, di/dt = 100A/μs	

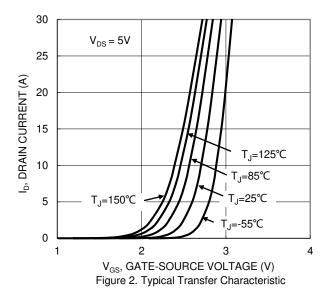
Notes:

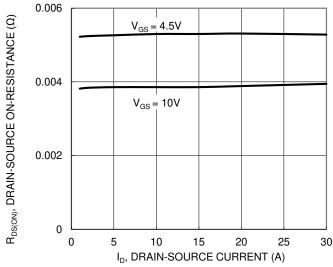
- Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
 Short duration pulse test used to minimize self-heating effect.

- 8. Guaranteed by design. Not subject to product testing.









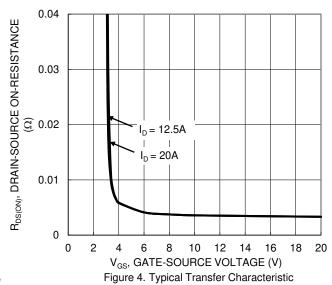


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

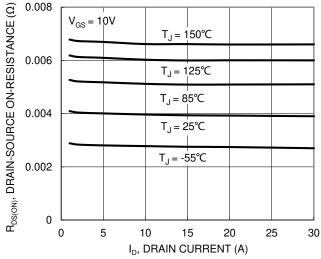
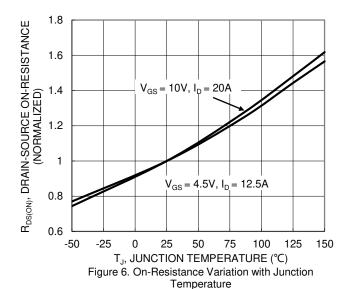


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature





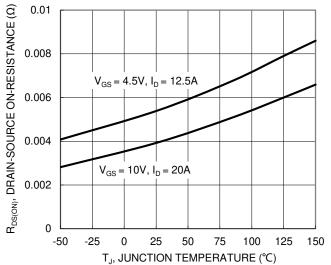


Figure 7. On-Resistance Variation with Junction Temperature

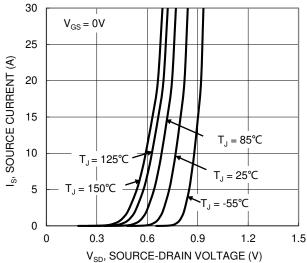
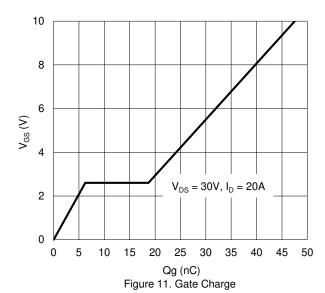


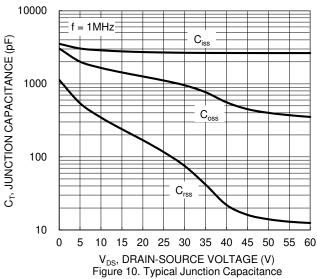
Figure 9. Diode Forward Voltage vs. Current



 $V_{GS(TH)},\; GATE\; THRESHOLD\; VOLTAGE\; (V)$ 2.5 2 $I_D = 1 \text{mA}$ 1.5 $I_{D} = 250 \mu A$ 1 0.5 0 -50 -25 0 25 50 75 100 125 150 T_J, JUNCTION TEMPERATURE (°C)

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Figure 8. Gate Threshold Variation vs. Junction Temperature



1000 $P_w = 100 \mu s$ 100 DRAIN CURRENT (A) 10 $P_W = 1 ms$ T_{J(Max)} = 150°C =10ms $T_A = 25^{\circ}C$ P_w =100ms Pw 0.1 فــ Single Pulse DUT on P_{W} =10s 1*MRP Board DC $V_{GS} = 10V$ 0.01 0.01 100 V_{DS} , DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



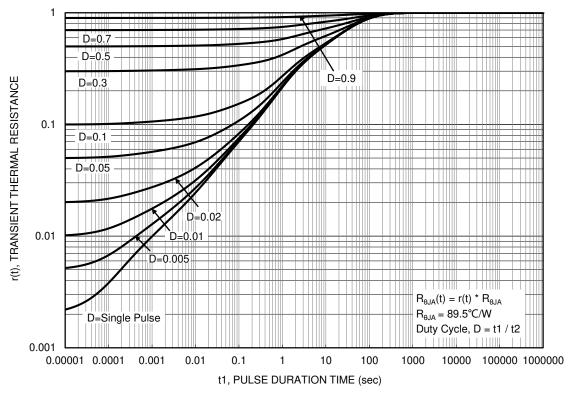


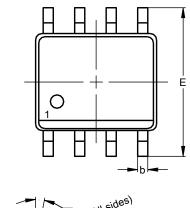
Figure 13. Transient Thermal Resistance

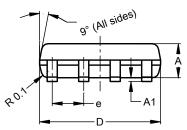


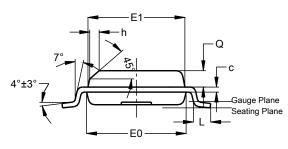
Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8





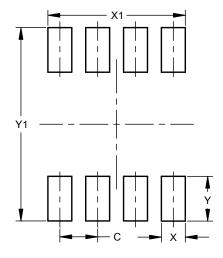


SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A 1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
е			1.27		
h	-		0.35		
L	0.62	0.82	0.72		
Q	0.60	0.70	0.65		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-8



Dimensions	Value (in mm)
С	1.27
Х	0.802
X1	4.612
Υ	1.505
Y1	6.50



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